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ALPHA & OMEGA SEMICONDUCTOR

AO4805

30V Dual P-Channel MOSFET

General Description

The AO4805 combines advanced trench MOSFET technology with a low resistance package to provide extremely low $R_{DS(ON)}$. This device is ideal for load switch and battery protection applications.

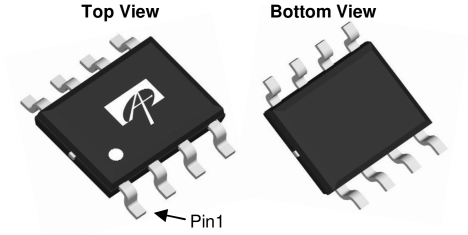
Product Summary

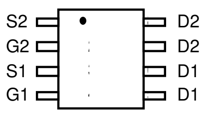
V_{DS}	-30V
I_D (at V_{GS}=-20V)	-9A
$R_{DS(ON)}$ (at V_{GS}=-20V)	< 15mΩ
$R_{DS(ON)}$ (at V_{GS} =-10V)	< 18mΩ

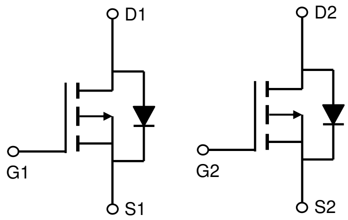
100% UIS Tested
100% R_g Tested

Green Product

SOIC-8







Absolute Maximum Ratings T_A=25°C unless otherwise noted				
Parameter		**Symbol**	**Maximum**	**Units**
Drain-Source Voltage		V_{DS}	-30	V
Gate-Source Voltage		V_{GS}	±25	V
Continuous Drain Current	T_A=25°C	I_D	-9	A
	T_A=70°C		-7	
Pulsed Drain Current [C]		I_{DM}	-50	
Avalanche Current [C]		I_{AS}, I_{AR}	33	A
Avalanche energy L=0.1mH [C]		E_{AS}, E_{AR}	54	mJ
Power Dissipation [B]	T_A=25°C	P_D	2	W
	T_A=70°C		1.3	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics					
Parameter		**Symbol**	**Typ**	**Max**	**Units**
Maximum Junction-to-Ambient [A]	t ≤ 10s	$R_{\theta JA}$	48	62.5	°C/W
Maximum Junction-to-Ambient [A D]	Steady-State		74	90	°C/W
Maximum Junction-to-Lead	Steady-State	$R_{\theta JL}$	32	40	°C/W

Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions		Min	Typ	Max	Units
STATIC PARAMETERS							
BV_{DSS}	Drain-Source Breakdown Voltage	I_D=-250µA, V_{GS}=0V		-30			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=-30V, V_{GS}=0V				-1	µA
			T_J=55°C			-5	
I_{GSS}	Gate-Body leakage current	V_{DS}=0V, V_{GS}=±25V				±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS} I_D=-250µA		-1.7	-2.3	-2.8	V
$I_{D(ON)}$	On state drain current	V_{GS}=-10V, V_{DS}=-5V		-50			A
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=-20V, I_D=-9A			10	15	mΩ
		V_{GS}=-10V, I_D=-8A			12	18	mΩ
			T_J=125°C		13	20	
		V_{GS}=-4.5V, I_D=-5A			29		mΩ
g_{FS}	Forward Transconductance	V_{DS}=-5V, I_D=-9A			27		S
V_{SD}	Diode Forward Voltage	I_S=-1A,V_{GS}=0V			-0.7	-1	V
I_S	Maximum Body-Diode Continuous Current					-2.5	A
DYNAMIC PARAMETERS							
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=-15V, f=1MHz			2060	2600	pF
C_{oss}	Output Capacitance				370		pF
C_{rss}	Reverse Transfer Capacitance				295		pF
R_g	Gate resistance	V_{GS}=0V, V_{DS}=0V, f=1MHz		1.2	2.4	3.6	Ω
SWITCHING PARAMETERS							
Q_g	Total Gate Charge	V_{GS}=-10V, V_{DS}=-15V, I_D=-9A			30	39	nC
Q_{gs}	Gate Source Charge				4.6		nC
Q_{gd}	Gate Drain Charge				10		nC
$t_{D(on)}$	Turn-On DelayTime	V_{GS}=-10V, V_{DS}=-15V, R_L=1.67Ω, R_{GEN}=3Ω			11		ns
t_r	Turn-On Rise Time				9.4		ns
$t_{D(off)}$	Turn-Off DelayTime				24		ns
t_f	Turn-Off Fall Time				12		ns
t_{rr}	Body Diode Reverse Recovery Time	I_F=-9A, dI/dt=100A/µs			30	40	ns
Q_{rr}	Body Diode Reverse Recovery Charge	I_F=-9A, dI/dt=100A/µs			22		nC

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C. The value in any given application depends on the user's specific board design.
B. The power dissipation P_D is based on $T_{J(MAX)}$=150°C, using ≤ 10s junction-to-ambient thermal resistance.
C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$=150°C. Ratings are based on low frequency and duty cycles to keep initialT_J=25°C.
D. The $R_{\theta JA}$ is the sum of the thermal impedence from junction to lead $R_{\theta JL}$ and lead to ambient.
E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.
F. These curves are based on the junction-to-ambient thermal impedence which is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J(MAX)}$=150°C. The SOA curve provides a single pulse ratin g.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

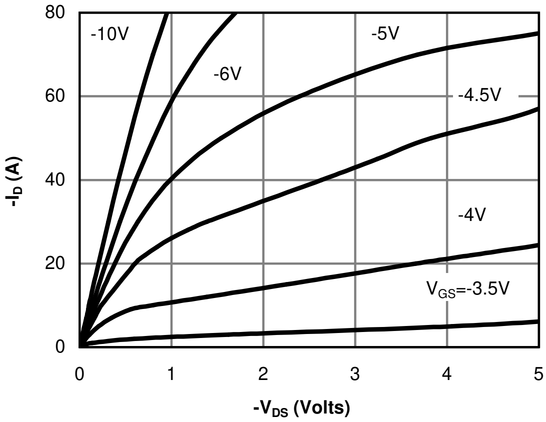


Fig 1: On-Region Characteristics (Note E)

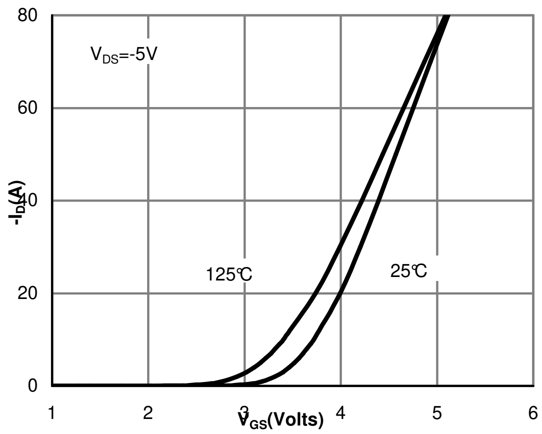


Figure 2: Transfer Characteristics (Note E)

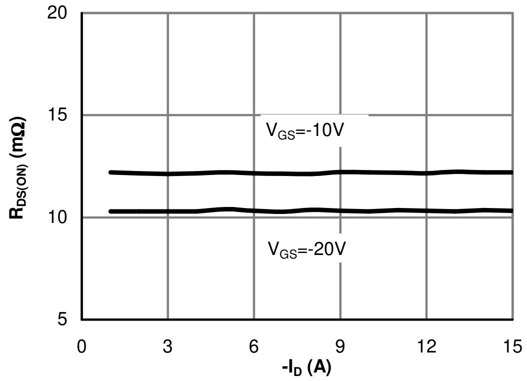


Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

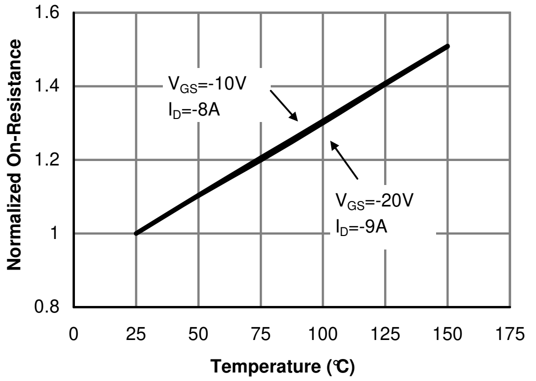


Figure 4: On-Resistance vs. Junction Temperature (Note E)

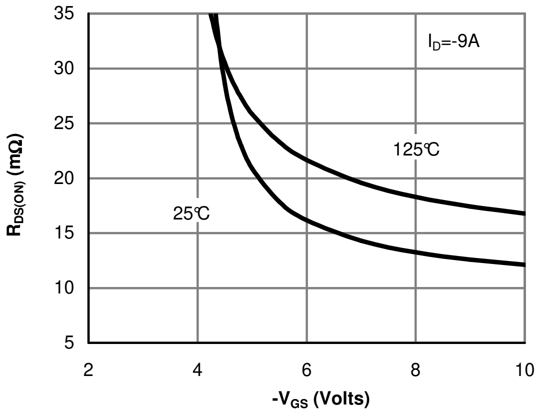


Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

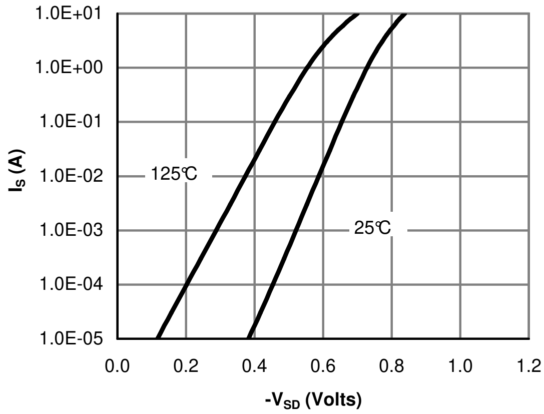


Figure 6: Body-Diode Characteristics (Note E)

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

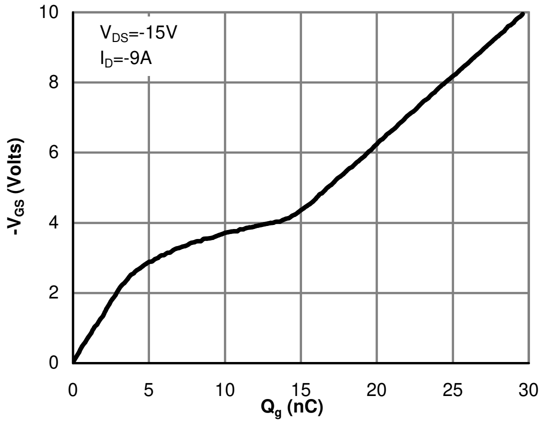


Figure 7: Gate-Charge Characteristics

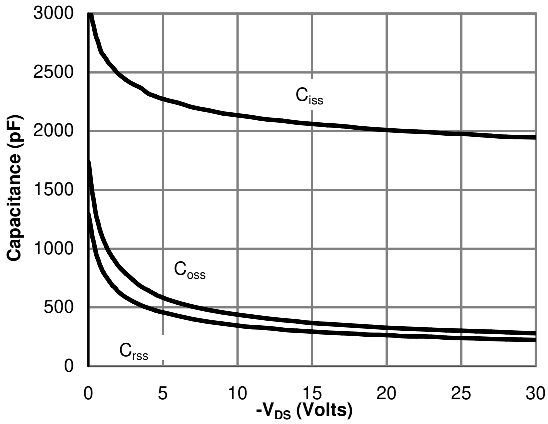


Figure 8: Capacitance Characteristics

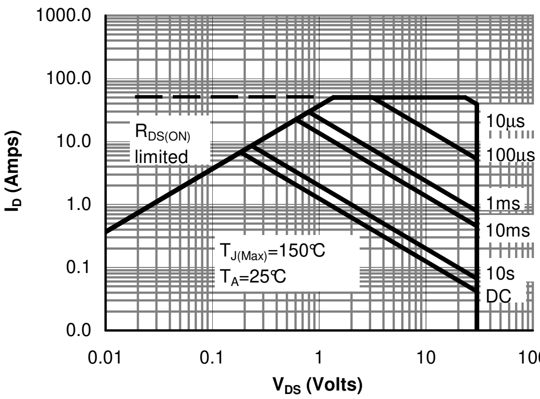


Figure 10: Maximum Forward Biased Safe Operating Area (Note F)

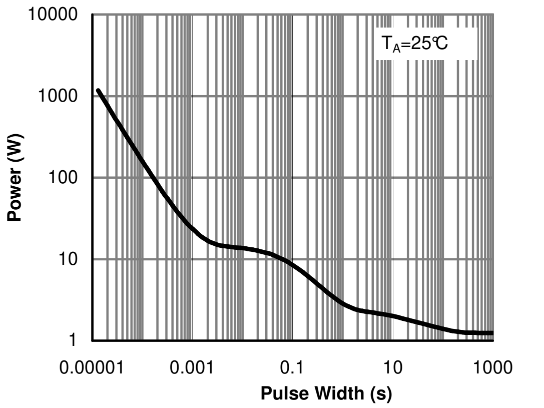


Figure 11: Single Pulse Power Rating Junction-to-Ambient (Note F)

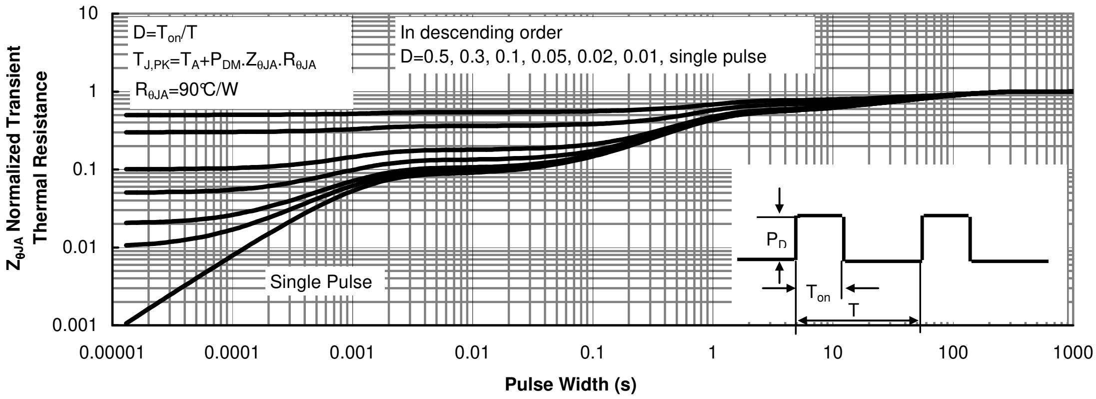
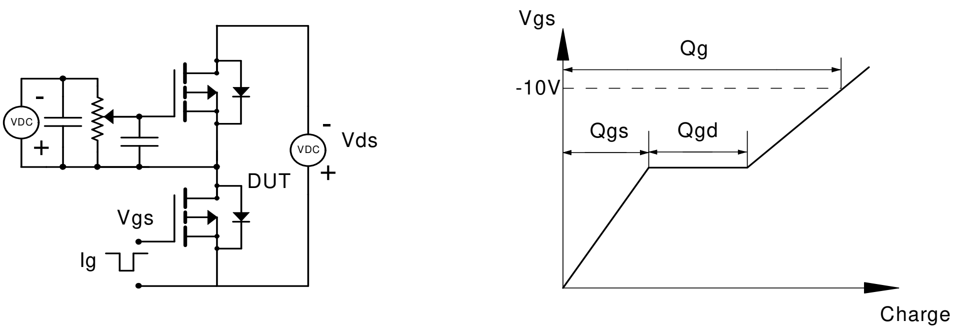
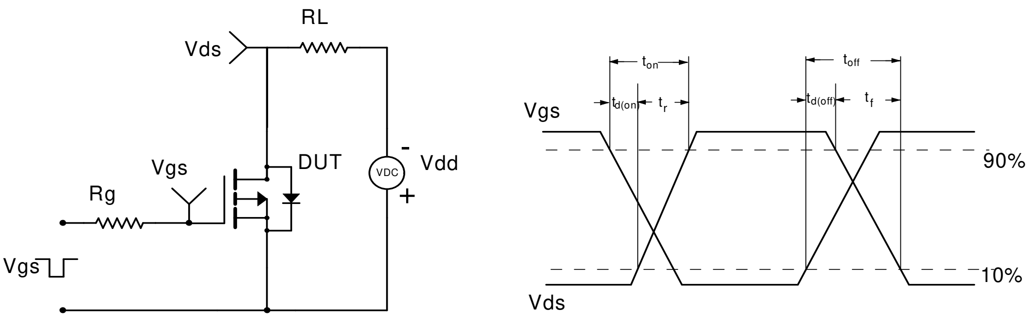


Figure 12: Normalized Maximum Transient Thermal Impedance (Note F)

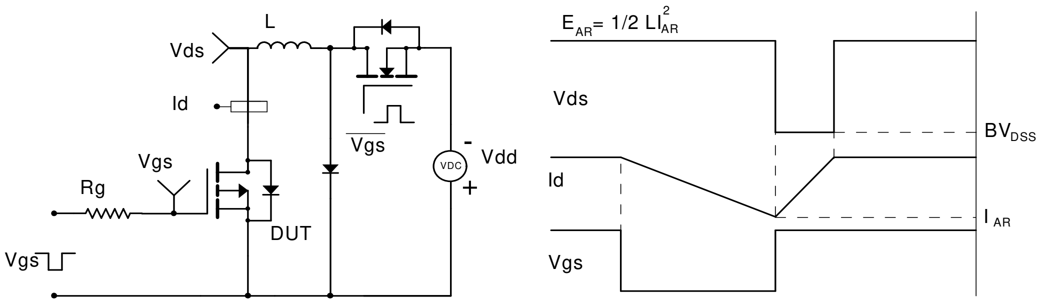
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms